

250V HALF-BRIDGE GATE DRIVER IN SO-8

Description

The DIODES™ DGD1504 is a high-voltage/high-speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD1504's high side to switch to 250V in a bootstrap operation.

The DGD1504 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. The DGD1504 has a fixed internal deadtime of 430ns (typical).

The DGD1504 is offered in the SO-8 (Type TH) package and operates over an extended -40°C to +125°C temperature range.

Applications

- DC-DC converters
- DC-AC inverters
- AC-DC power supplies
- Motor controls
- Class D power amplifiers

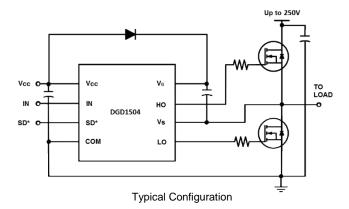
Features

- Floating High-Side Driver in Bootstrap Operation to 250V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge
- 290mA Source/600mA Sink Output Current Capability
- **Outputs Tolerant to Negative Transients**
- Internal Dead Time of 430ns to Protect MOSFETs
- Wide Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (IN and SD*) 3.3V Capability
- Schmitt Triggered Logic Inputs
- Undervoltage Lockout for Vcc (Logic and Low Side Supply)
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (Approximate)





SO-8 (Type TH)

Top View

August 2022

Ordering Information (Note 4)

| Part Number | Pookogo | Marking | Reel Size (inch) | Tape Width (mm) | Packing | | |
|--------------|----------------|---------|------------------|------------------|---------|---------|--|
| Part Number | Package | | | rape widin (min) | Qty. | Carrier | |
| DGD1504S8-13 | SO-8 (Type TH) | DGD1504 | 13 | 12 | 2,500 | Reel | |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

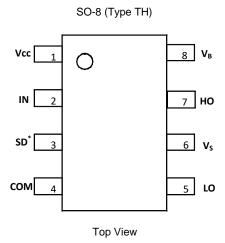


Marking Information



☐ Manufacturer's Marking
☐ DGD1504 = Product Type Marking Code
YY = Year (ex: 22 = 2022)
WW = Week (01 to 53)

Pin Diagram

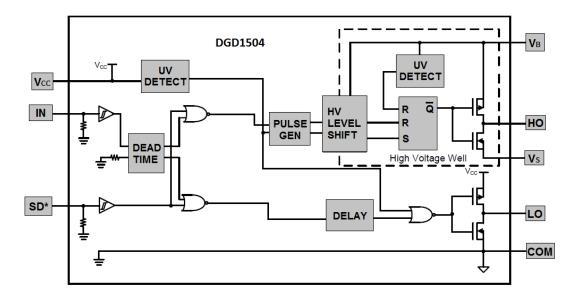


Pin Descriptions

| Pin Number | Pin Name | Function |
|------------|----------|--|
| 1 | Vcc | Logic and Low Side Supply |
| 2 | IN | Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO |
| 3 | SD* | Logic Input for Shutdown, Enabled Low |
| 4 | COM | Low-Side and Logic Return |
| 5 | LO | Low-Side Gate Drive Output |
| 6 | Vs | High-Side Floating Supply Return |
| 7 | НО | High-Side Gate Drive Output |
| 8 | VB | High-Side Floating Supply |



Functional Block Diagram



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|-----------------|--|------|
| High-Side Floating Supply Voltage | VB | -0.3 to +274 | V |
| High-Side Floating Supply Offset Voltage | Vs | V _B -24 to V _B +0.3 | V |
| High-Side Floating Output Voltage | V _{HO} | V _S -0.3 to V _B +0.3 | V |
| Offset Supply Voltage Transient | dVs/dt | 50 | V/ns |
| Low-Side Fixed Supply Voltage | Vcc | -0.3 to +24 | V |
| Low-Side Output Voltage | V_{LO} | -0.3 to V _{CC} +0.3 | V |
| Logic Input Voltage (IN and SD*) | V_{IN} | -0.3 to V _{CC} +0.3 | V |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---|--------|-------------|------|
| Power Dissipation Linear Derating Factor (Note 5) | PD | 0.625 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | Reja | 200 | °C/W |
| Operating Temperature | TJ | +150 | |
| Lead Temperature (Soldering, 10s) | TL | +300 | °C |
| Storage Temperature Range | Tstg | -55 to +150 | |

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

| Parameter | Symbol | Min | Max | Unit |
|--|----------------|---------------------|---------------------|------|
| High Side Floating Supply Absolute Voltage | V _B | V _S + 10 | V _S + 20 | V |
| High Side Floating Supply Offset Voltage | Vs | (Note 6) | 250 | V |
| High Side Floating Output Voltage | Vно | Vs | V _B | V |
| Low Side Fixed Supply Voltage | Vcc | 10 | 20 | V |
| Low Side Output Voltage | VLO | 0 | Vcc | V |
| Logic Input Voltage (IN and SD*) | VIN | 0 | 5 | V |
| Ambient Temperature | TA | -40 | +125 | °C |

Note: 6. Logic operation for V_S of -5V to +250V. Logic state held for V_S of -5V to - V_{BS} .



DC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, @TA = +25°C, unless otherwise specified.) (Note 7)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|--|--------------------|-----|------|-----|----------|------------------------------|
| Logic "1" (IN) & Logic "0" (SD*) Input Voltage | ViH | 2.5 | _ | _ | V | Vcc = 10V to 20V |
| Logic "0" (IN) & Logic "1" (SD*) Input Voltage | V_{IL} | _ | _ | 0.8 | V | V _{CC} = 10V to 20V |
| High Level Output Voltage, VBIAS - VO | Vон | _ | 0.05 | 0.2 | V | Io = 2mA |
| Low Level Output Voltage, Vo | Vol | _ | 0.02 | 0.1 | V | Io = 2mA |
| Offset Supply Leakage Current | ILK | _ | _ | 50 | μΑ | $V_B = V_S = 250V$ |
| Quiescent V _{BS} Supply Current | I _{BSQ} | _ | 60 | 100 | μΑ | $V_{IN} = 0V \text{ or } 5V$ |
| Quiescent Vcc Supply Current | Iccq | _ | 350 | 500 | μΑ | V _{IN} = 0V or 5V |
| Logic "1" Input Bias Current | I _{IN+} | _ | 3.0 | 10 | μΑ | $V_{IN} = 5V, SD^* = 0V$ |
| Logic "0" Input Bias Current | I _{IN-} | _ | _ | 5.0 | μΑ | $V_{IN} = 0V, SD^* = 5V$ |
| V _{CC} Supply Undervoltage Positive Going Threshold | V _{CCUV+} | 7.4 | 8.5 | 9.6 | V | _ |
| Vcc Supply Undervoltage Negative Going Threshold | Vccuv- | 7.1 | 7.8 | 8.8 | V | _ |
| V _{BS} Supply Undervoltage Positive Going Threshold | V _{BSUV+} | 5.5 | 6.5 | 7.5 | V | _ |
| V _{BS} Supply Undervoltage Negative Going Threshold | V_{BSUV} | 5.3 | 6.3 | 7.3 | V | _ |
| Output High Short Circuit Pulsed Current | lo+ | 130 | 290 | _ | mA | Vo = 0V, Pw ≤ 10µs |
| Output Low Short Circuit Pulsed Current | lo- | 270 | 600 | _ | mA | Vo = 15V, Pw ≤ 10μs |

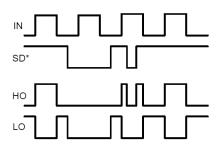
Note: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

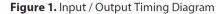
AC Electrical Characteristics (V_{BIAS} (V_{CC} , V_{BS}) = 15V, C_L = 1000pF, @ T_A = +25°C, unless otherwise specified.)

| Parameter | Symbol | Min | Тур | Max | Unit | Condition |
|---|-----------------|-----|-----|-----|------|-----------|
| Turn-on Propagation Delay | ton | _ | 680 | 820 | ns | Vs = 0V |
| Turn-off Propagation Delay | toff | _ | 150 | 220 | ns | Vs = 250V |
| Shutdown Propagation Delay | t _{SD} | _ | 160 | 220 | ns | _ |
| Delay Matching, HO and LO Turn-on/Turn-off | t _{DM} | _ | _ | 60 | ns | _ |
| Turn-on Rise Time | tR | _ | 70 | 170 | ns | Vs = 0V |
| Turn-off Fall Time | tF | _ | 35 | 90 | ns | Vs = 0V |
| Deadtime: t _{DT LO-HO} & t _{DT HO-LO} | t _{DT} | 300 | 430 | 550 | ns | _ |



Timing Waveforms





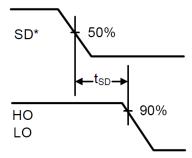


Figure 2. Shutdown Waveform Definition

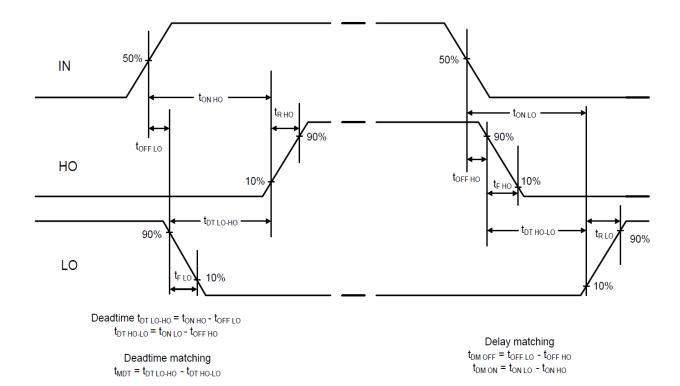


Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)

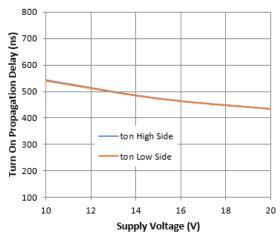


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

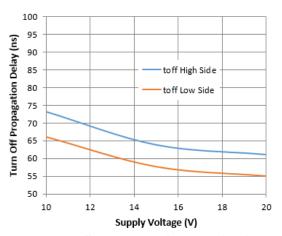


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

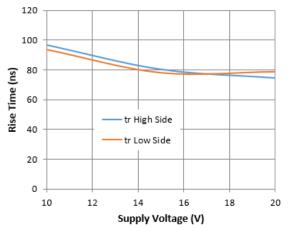


Figure 8. Rise Time vs. Supply Voltage

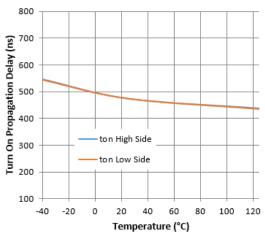


Figure 5. Turn-on Propagation Delay vs. Temperature

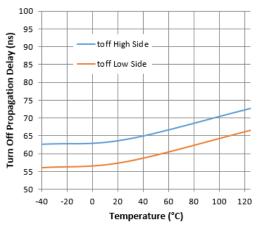


Figure 7. Turn-off Propagation Delay vs. Temperature

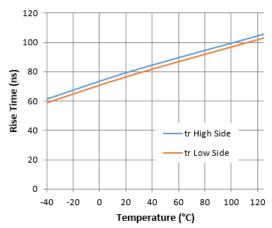


Figure 9. Rise Time vs. Temperature



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.) (continued)

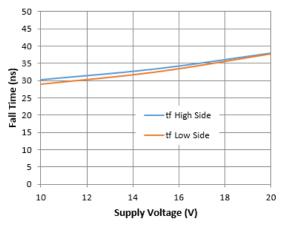


Figure 10. Fall Time vs. Supply Voltage

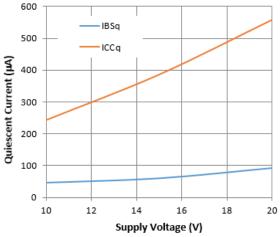


Figure 12. Quiescent Current vs. Supply Voltage

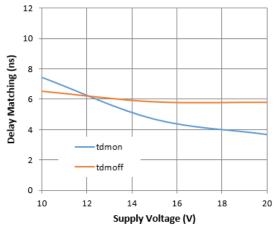


Figure 14. Delay Matching vs. Supply Voltage

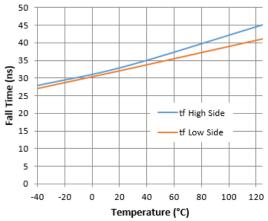


Figure 11. Fall Time vs. Temperature

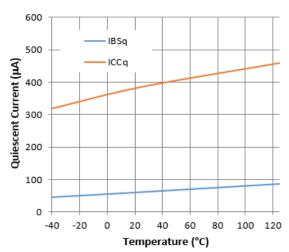


Figure 13. Quiescent Current vs. Temperature

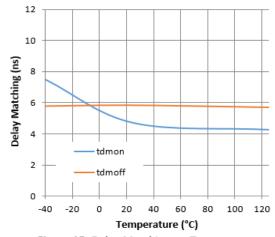


Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.) (continued)

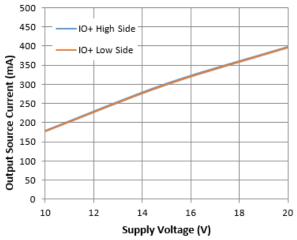


Figure 16. Output Source Current vs. Supply Voltage

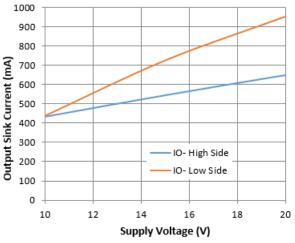


Figure 18. Output Sink Current vs. Supply Voltage

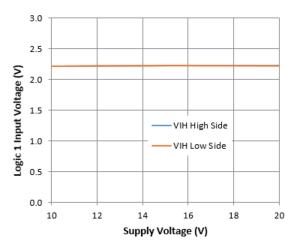


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

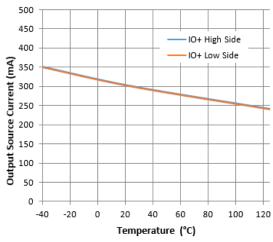


Figure 17. Output Source Current vs. Temperature

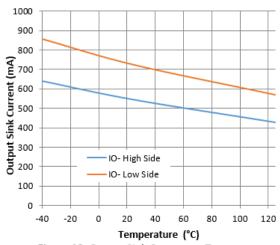


Figure 19. Output Sink Current vs. Temperature

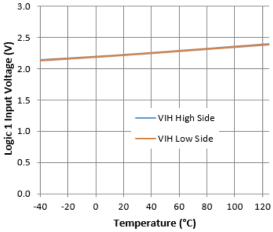


Figure 21. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.) (continued)

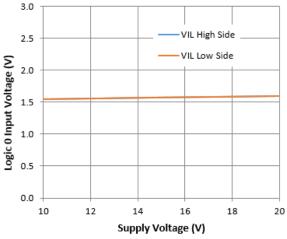


Figure 22. Logic O Input Voltage vs. Supply Voltage

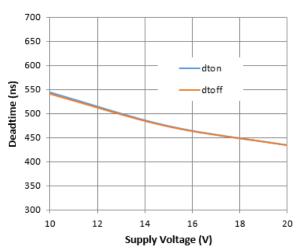


Figure 24. Deadtime vs. Supply Voltage

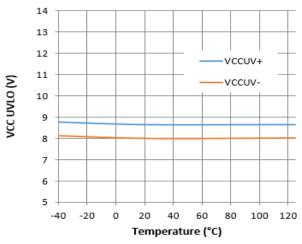


Figure 26. VCC UVLO vs. Temperature

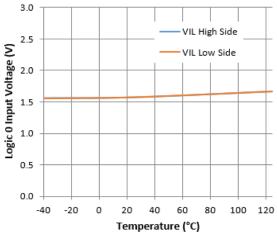


Figure 23. Logic 0 Input Voltage vs. Temperature

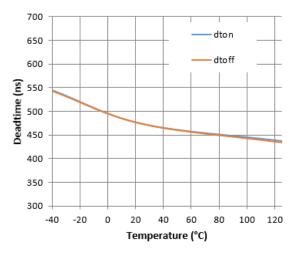


Figure 25. Deadtime vs. Temperature

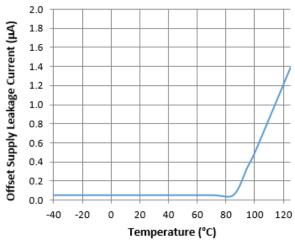


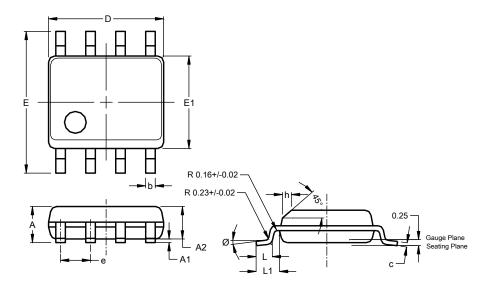
Figure 27. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)

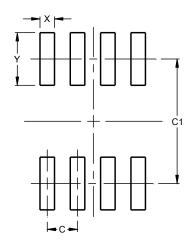


| SO-8 (Type TH) | | | | | |
|----------------------|-------|-------|------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 1.35 | 1.75 | | | |
| A1 | 0.10 | 0.25 | | | |
| A2 | | | 1.45 | | |
| b | 0.35 | 0.51 | | | |
| С | 0.190 | 0.248 | | | |
| D | 4.80 | 5.00 | 4.90 | | |
| Е | 5.80 | 6.20 | 6.00 | | |
| E1 | 3.80 | 4.00 | 3.90 | | |
| е | | | 1.27 | | |
| h | 0.25 | 0.50 | | | |
| L | 0.41 | 1.27 | | | |
| L1 | | | 1.04 | | |
| Ø | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)



| Dimensions | Value (in mm) | | | |
|-------------------|---------------|--|--|--|
| С | 1.27 | | | |
| C1 | 5.20 | | | |
| Х | 0.60 | | | |
| Y | 2.20 | | | |

Note: 8. For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



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